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40. (New) A document made of a safety paper according to
claim 22, wherein the circuit chip (4, 40) is arranged in an area
of the document that is not printed.

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41. (New) A document made of a safety paper according to
claim 22, wherein, in an area which is remote from the area in
which the electronic circuit (4, 40) is arranged, an authenticity
feature is arranged that is detectable contactless and can be
input into the circuit and checked therein.

REMARKS

Claims 22 to 49 are in the application. They replace claims
1 to 21 which have been deleted.

With the respect to the rejection of the claims under 35
U.S.C. 112, first paragraph, the Examiner will note that the
limitation of original claim 19 is no longer recited in the
claims.

In rewriting the claims, the problems referred to by the
Examiner have been eliminated. Accordingly, reconsideration and
withdrawal of the rejection of the claims under 35 U.S.C. 112,
second paragraph, should be withdrawn.

The claims have been rewritten in order to distinguish them over the references of record.

With respect to the reference to Baldi (EP 905657A), this reference was published after the priority date claimed in the present application. Submitted herewith are translations of the priority documents. Accordingly, the reference to Baldi has been eliminated as a reference.

Therefore, in view of the foregoing, it is submitted that this application is now in condition for allowance and such allowance is respectfully solicited.

Any additional fees or charges required at this time in connection with the application may be charged to Patent and Trademark Office Deposit Account No. 11-1835.

Respectfully submitted,

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on March 5, 2003

By: F. Kueffner
Friedrich Kueffner

Date: March 5, 2003